



Switching Diode  
DA3X101J0L

## DA3X101J0L

Silicon epitaxial planar type

For high speed switching circuits  
DA3J101J in Mini3 type package

### ■ Features

- Small reverse current IR
- Short reverse recovery time trr
- Halogen-free / RoHS compliant  
(EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

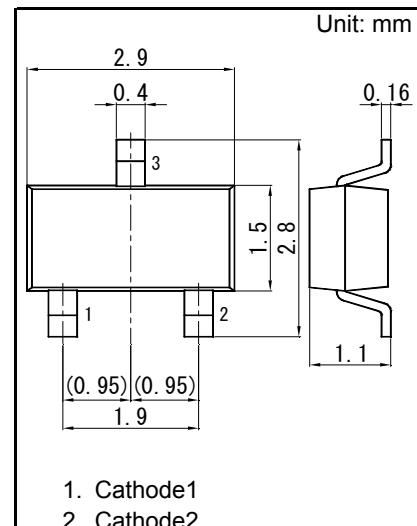
### ■ Marking Symbol: 11

### ■ Basic Part Number :

2 elements anode-common type

### ■ Packaging

Embossed type (Thermo-compression sealing) : 3 000 pcs / reel (standard)



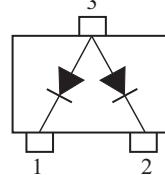
Panasonic	Mini3-G3-B
JEITA	SC-59A
Code	TO-236AA/SOT-23

### ■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit
Reverse voltage	VR	80	V
Maximum peak reverse voltage	VRM	80	V
Forward current	Single	100	mA
	Double	150	
Peak forward current	Single	225	mA
	Double	340	
Non-repetitive peak forward surge current <sup>*1</sup>	Single	500	mA
	Double	750	
Junction temperature	T <sub>j</sub>	150	°C
Operating ambient temperature	T <sub>opr</sub>	-40 to +85	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

Note) \*1: t = 1 s

### Internal Connection





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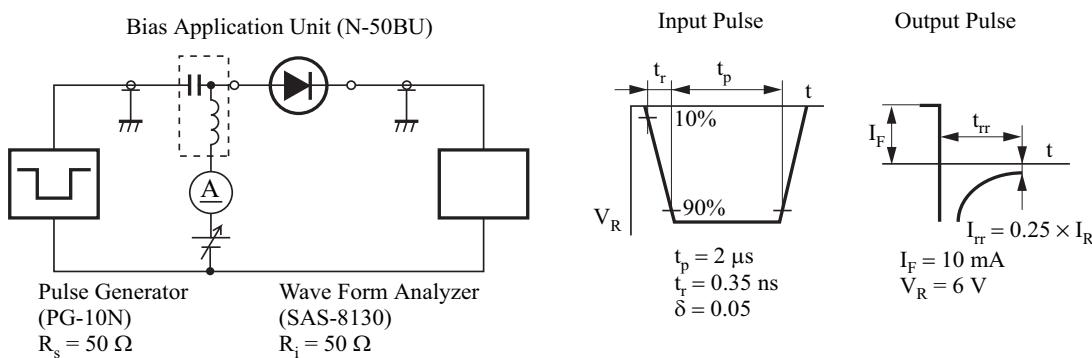
■ Electrical Characteristics  $T_a = 25 \text{ }^{\circ}\text{C} \pm 3 \text{ }^{\circ}\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Forward voltage	VF	IF = 100 mA			1.2	V
Reverse voltage	VR	IR = 100 $\mu\text{A}$	80			V
Reverse current	IR	VR = 80 V			100	nA
Terminal capacitance	Ct	VR = 0 V, f = 1 MHz			2	pF
Reverse recovery time <sup>1</sup>	trr	IF = 10mA, VR = 6V Irr = 0.25 $\times$ IR			3	ns

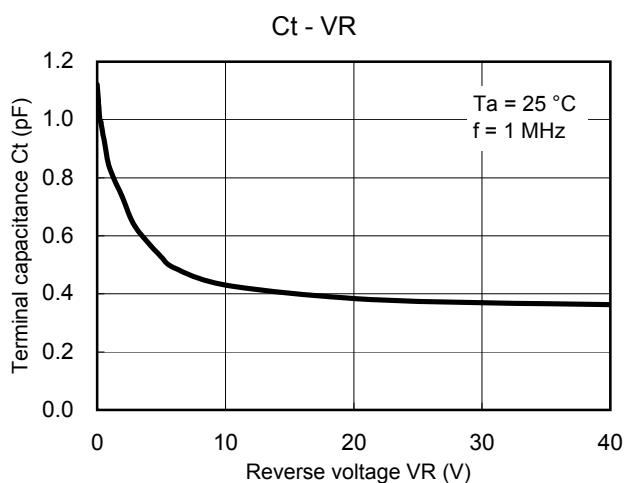
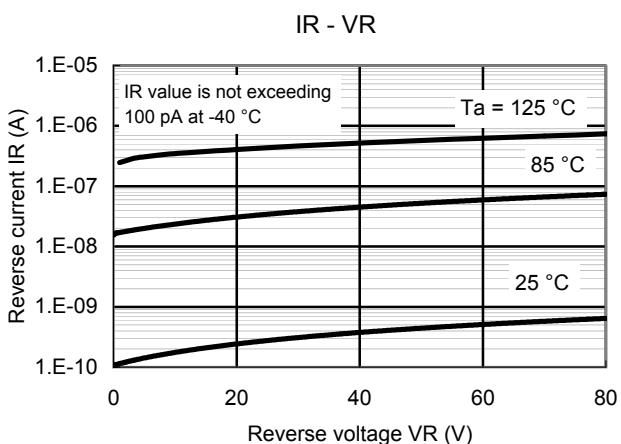
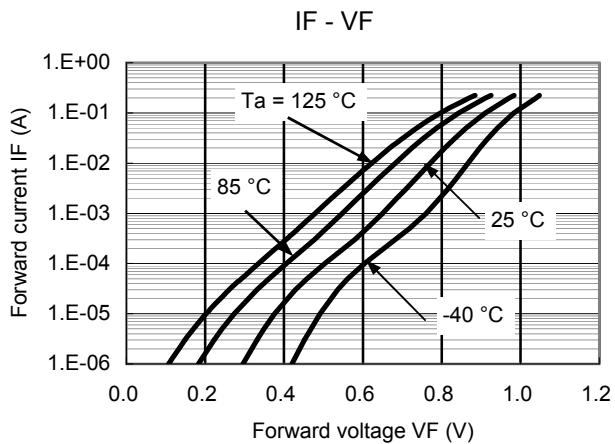
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.

2. Absolute frequency of input and output is 100 MHz.

3. <sup>1</sup>: trr test circuit



Technical Data ( reference )

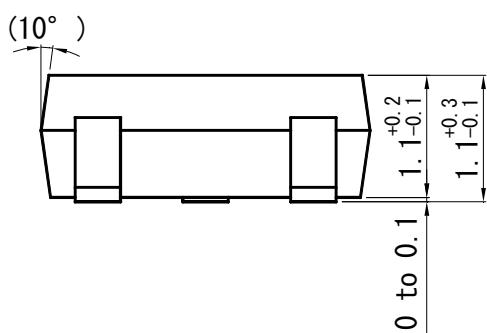
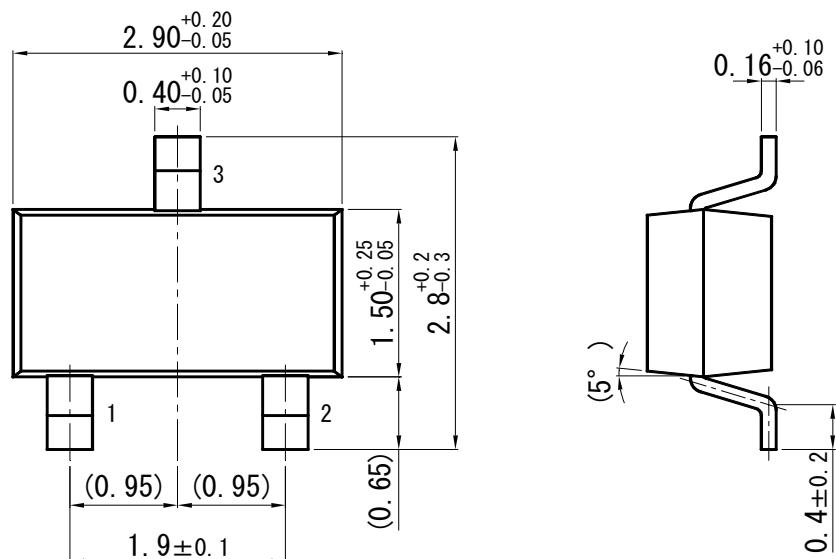


**Panasonic**

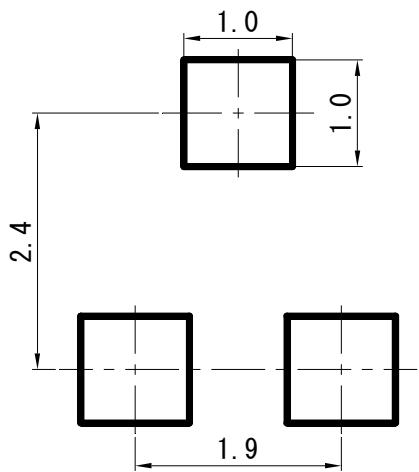
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Mini3-G3-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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